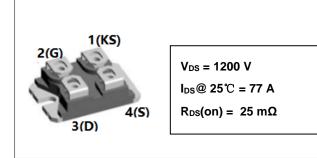
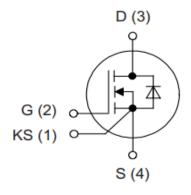




# S3M0025120N 1200V SIC POWER MOSFET



### **Circuit Diagram**



### **Description**

S3M0025120N is single SiC Power MOSFET packaged in SOT-227 case. The device is a high voltage n-channel Enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S3M0025120N is ideal for energy sensitive, high frequency applications in challenging environments.

#### **Features**

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 25 m $\Omega$ .
- Fast switching speed and low switching losses.
- · Very fast and robust intrinsic body diode.
- · Process of non-bright Tin electroplatin.

### **Applications**

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)





# Maximum Ratings (T<sub>A</sub> = 25 °C, unless otherwise specified)

Characteristics	Symbol	Conditions	Min.	Тур.	Max.	Units	Note
Drain - Source Voltage	V <sub>DSmax</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 100 μA			1200	V	
Gate - Source Voltage (dynamic)	VGSmax	AC (f > 1 Hz)	-8		+22	V	
Gate - Source Voltage (static)	V <sub>GSop</sub>	Static		-4 / +18		V	[1]
Continuous Drain Current	,	V <sub>GS</sub> = 18 V, T <sub>C</sub> = 25 °C			77	۸	
Continuous Drain Current	I <sub>D</sub>	V <sub>GS</sub> = 18 V, T <sub>C</sub> = 100 °C			54	А	
Pulsed Drain Current	I <sub>D(pulse)</sub>	Pulse width t <sub>P</sub> limited by T <sub>jmax</sub>			200	А	
Power Dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C			517	W	

<sup>[1]</sup> Recommended turn off gate voltage is -4 V. Recommended turn on gate voltage is 18 V. Do not use with V<sub>GSON</sub> < 12 V.





# Electrical Characteristics (T<sub>A</sub> = 25 °C, unless otherwise specified)

Characteristics	Symbol	Conditions	Min.	Тур.	Max.	Units
Drain Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$	1200			V
		$V_{DS} = V_{GS}$ , $I_D = 20 \text{ mA}$	2	2.5	4	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 20 mA, T <sub>J</sub> = 175 °C		1.6		V
Zero Gate Voltage Drain Current	Ioss	V <sub>DS</sub> = 1200 V, V <sub>GS</sub> = 0 V		1	100	μΑ
Gate Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = 18 V, V <sub>DS</sub> = 0 V		10	250	nA
Drain Source On-State	_	V <sub>GS</sub> = 18 V, I <sub>D</sub> = 48 A		25	32	mΩ
Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 18 V, I <sub>D</sub> = 48 A, T <sub>J</sub> = 175 °C		36		mΩ
Transconductance	gfs -	V <sub>DS</sub> = 20 V, I <sub>DS</sub> = 48 A		28		S
		V <sub>DS</sub> = 20 V, I <sub>DS</sub> = 48 A, T <sub>J</sub> = 175 °C		27		S
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V		3519		
Output Capacitance	Coss	V <sub>DS</sub> = 1000 V		151		pF
Reverse Transfer Capacitance	Crss	V <sub>AC</sub> = 25 mV		19		
Coss Stored Energy	Eoss	f = 1 MHz		91		μJ
Turn-On Switching Energy	Eon	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = -4 / 18 V		260		1
Turn-Off Switching Energy	Eoff	$I_D = 48 \text{ A}, R_{G(ext)} = 2.5 \Omega, L = 99 \text{ uH}$		231		μЈ
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = -4 / 18 V		13		na
Rise Time	tr	$I_D = 48 \text{ A}, R_{G(ext)} = 2.5 \Omega$		16		ns

<sup>•</sup> China - Germany - Korea - Singapore - United States •

<sup>•</sup> http://www.smc-diodes.com - sales@ smc-diodes.com •



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Technical Data Data Sheet N2843, REV				RoHS	
Turn-Off Delay Time	$t_{d(off)}$	Inductive Load Timing relative to	33		
Fall Time	t <sub>f</sub>	VDS Per IEC60747-8-4 pg 83	8		
Internal Gate Resistance	R <sub>G(int)</sub>	f = 1 MHz, AC = 25 mV	1.6		Ω
Gate to Source Charge	Qgs	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = -4 / 18 V	80		
Gate to Drain Charge	$Q_{gd}$	I <sub>D</sub> = 48 A	41		nC
Total Gate Charge	Qg	Per IEC60747-8-4 pg 21	175		

# Reverse Diode Characteristics (T<sub>A</sub> = 25 °C, unless otherwise specified)

Characteristics	Symbol	Conditions	Тур.	Max.	Units
Diada Farward Voltage	$V_{SD}$	V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 24 A	5.2		V
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 24 A, T <sub>J</sub> = 175°C	4.5		V
Continuous Diode Forward Current	Is	V <sub>GS</sub> = -4 V, T <sub>C</sub> = 25 °C	121		А
Reverse Recovery Time	t <sub>rr</sub>	V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 48 A, T <sub>J</sub> = 25 °C	18		ns
Reverse Recovery Charge	$Q_{rr}$	V <sub>R</sub> = 800V	260		nC
Peak Reverse Recovery Current	I <sub>mm</sub>	dif / dt = 2500 A / μs	21		А

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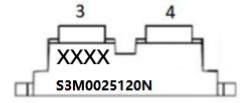
## **Thermal-Mechanical Specifications**

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R <sub>0</sub> JC	DC operation	0.29	°C/W

# Ordering Information

Device	Package	Shipping
S3M0025120N	SOT-227	36pcs/box

# **Marking Diagram**



Where XXXXX is YYWWL

S3M = Device Type 0025

120

= R<sub>DS</sub>(on) = Reverse Voltage (1200V) = Package = SSG SSG = Year WW = Week

Cautions: Molding resin

Epoxy resin UL:94V-0





### **Ratings and Characteristics Curves**

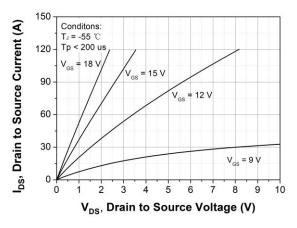


Figure 1. Output Characteristics T<sub>J</sub> = -55 °C

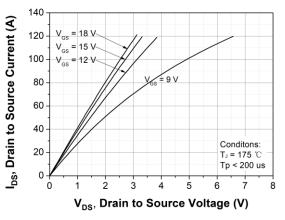


Figure 3. Output Characteristics T<sub>J</sub> = 175 °C

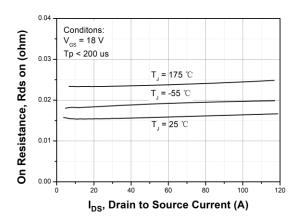


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

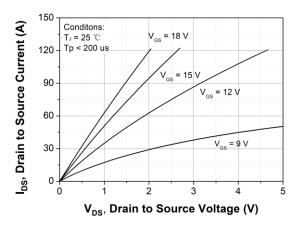


Figure 2. Output Characteristics T<sub>J</sub> = 25 °C

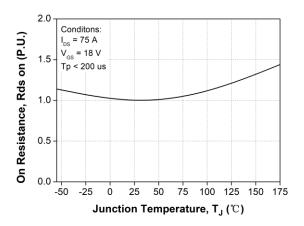


Figure 4. Normalized On-Resistance vs. Temperature

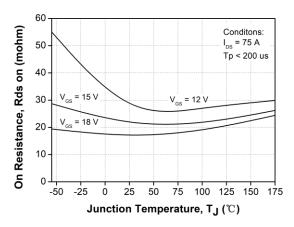


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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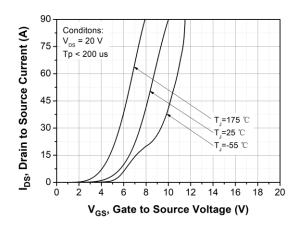


Figure 7. Transfer Characteristic for Various Junction Temperatures

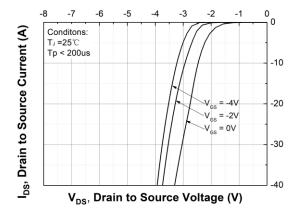


Figure 9. Body Diode Characteristic at T<sub>J</sub> = 25 °C

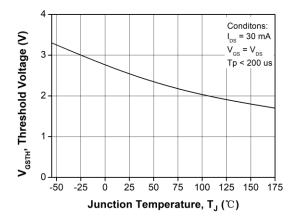


Figure 11. Threshold Voltage vs. Temperature

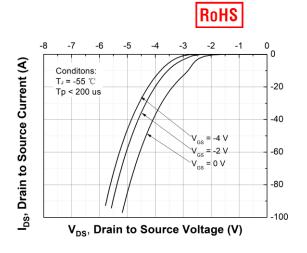


Figure 8. Body Diode Characteristic at T<sub>J</sub> = -55 °C

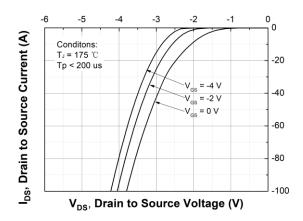


Figure 10. Body Diode Characteristic at T<sub>J</sub> = 175 °C

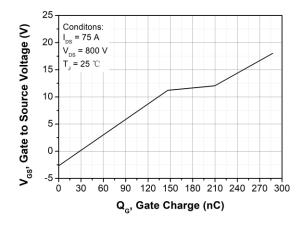


Figure 12. Gate Charge Characteristic

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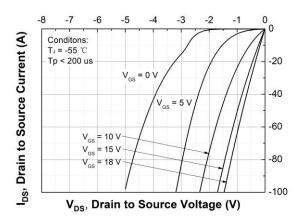


Figure 13. 3rd Quadrant Characteristic at T<sub>J</sub> = -55 °C

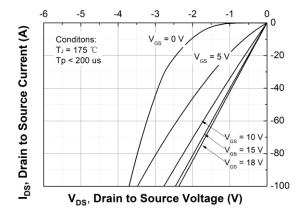


Figure 15. 3rd Quadrant Characteristic at T<sub>J</sub> = 175 °C

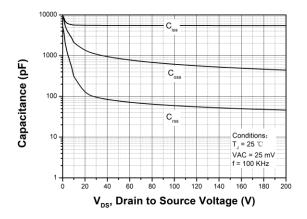


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200 V)

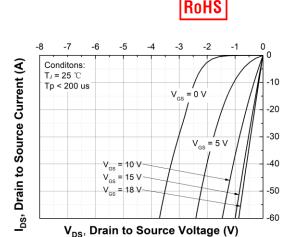


Figure 14. 3rd Quadrant Characteristic at T<sub>J</sub> = 25 °C

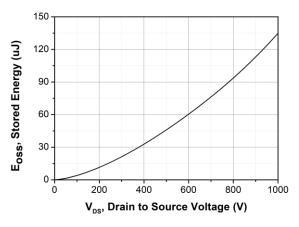


Figure 16. Output Capacitor Stored Energy

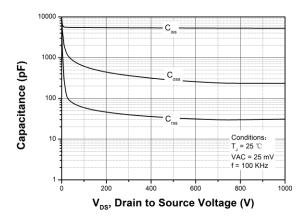


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000 V)

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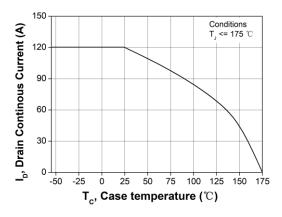


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

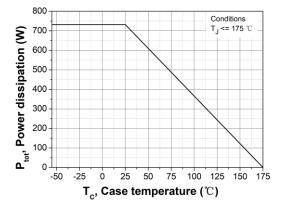


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

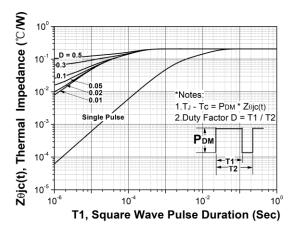


Figure 21. Transient Thermal Impedance (Junction - Case)

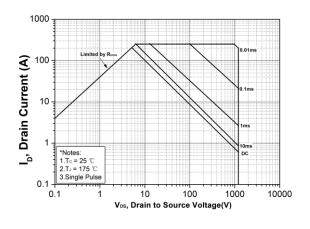


Figure 22. Safe Operating Area

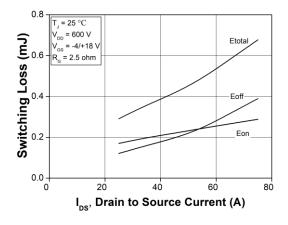


Figure 23. Clamped Inductive Switching Energy vs. Drain Current ( $V_{DD} = 600V$ )

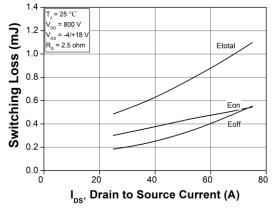


Figure 24. Clamped Inductive Switching Energy vs. Drain Current ( $V_{DD} = 800V$ )

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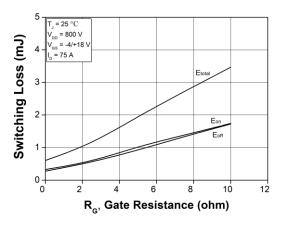


Figure 25. Clamped Inductive Switching Energy vs. R<sub>G(ext)</sub>

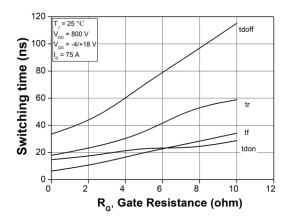


Figure 27. Switching Times vs. R<sub>G(ext)</sub>

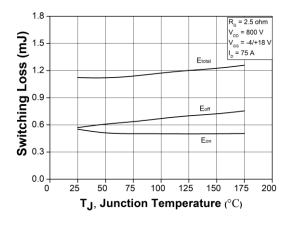


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

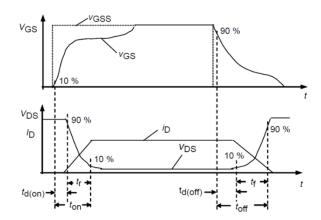
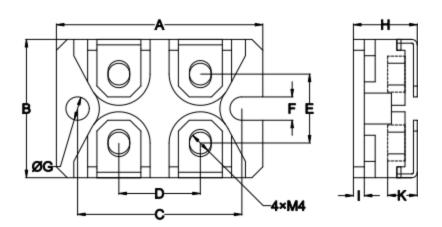


Figure 28. Switching Times Definition





# **Mechanical Dimensions SOT-227**



SYMBOL	Dimensions in millimeters			
	Min.	Max.		
Α	37.8	38.2		
В	24.8	25.21		
С	29.9	30.55		
D	14.5	15.5		
Е	12.2	13.45		
F	4.1	4.31		
G	φ4.1	φ4.31		
Н	11	12.5		
I	1.9	2.1		
K	4.3	6.5		

### S3M0025120N



### Technical Data Data Sheet N2843, REV.-



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